

FEATURES:

High output power & high brightness

- 0.5W CW Output Power
- 50 $\mu\text{m} \times 1 \mu\text{m}$ Emitting Area

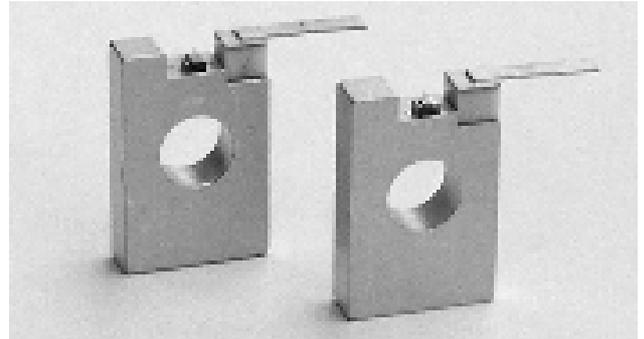
Peak Emission Wavelength 808nm \pm 5nm

Multimode

High Stability

Long Life

Compact



APPLICATIONS:

Pumping source for Solid State Laser

Printing

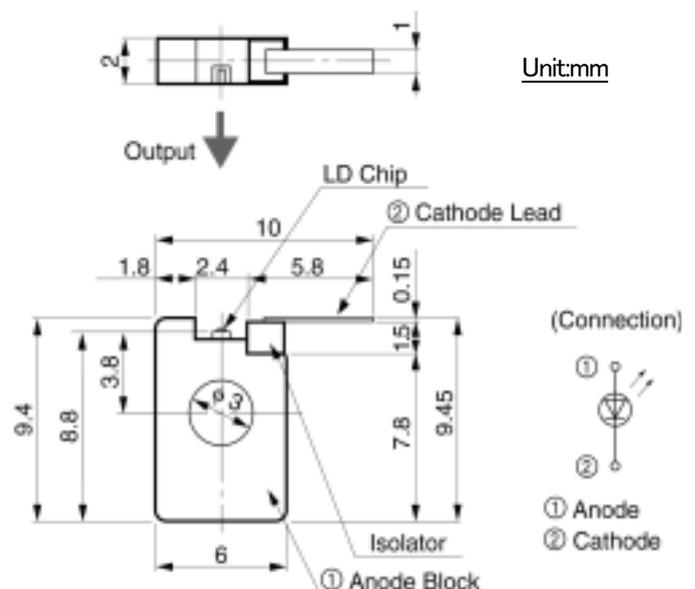
Medical Instrument

Measuring Instrument

ABSOLUTE MAXIMUM RATINGS

(Top(c)=25°C)

Parameter	Symbol	Value	Unit
Radiant Output Power	ϕ_e	0.6	W
Reverse Voltage	V_R	2	V
Operating Temperature	$T_{op(c)}$	0 to +30	°C
Storage Temperature	T_{stg}	-30 to +80	°C



ELECTRICAL AND OPTICAL CHARACTERISTICS

(Top(c)=25°C)

Parameter	Symbol	Condition	Value			Unit	
			Min.	Typ.	Max.		
Forward Current	I_F	$\phi_e=0.5W$	-	0.65	0.75	A	
Peak Emission Wavelength	λ_p	$\phi_e=0.5W$	803	808	813	nm	
Spectral Radiation Half Bandwidth	$\Delta\lambda$	$\phi_e=0.5W$	-	2	3	nm	
Forward Voltage	V_F	$\phi_e=0.5W$	-	2	2.4	V	
Beam Spread Angle	θ	$\phi_e=0.5W$	FWHM	4	8	12	degree
				27	32	37	degree
Lasing Threshold Current	I_{th}	-	-	0.15	0.25	A	

808nm 0.5W CW Laser Diode L8933-61

Figure 1: Radiant Output Power vs. Forward Current (Typ.)

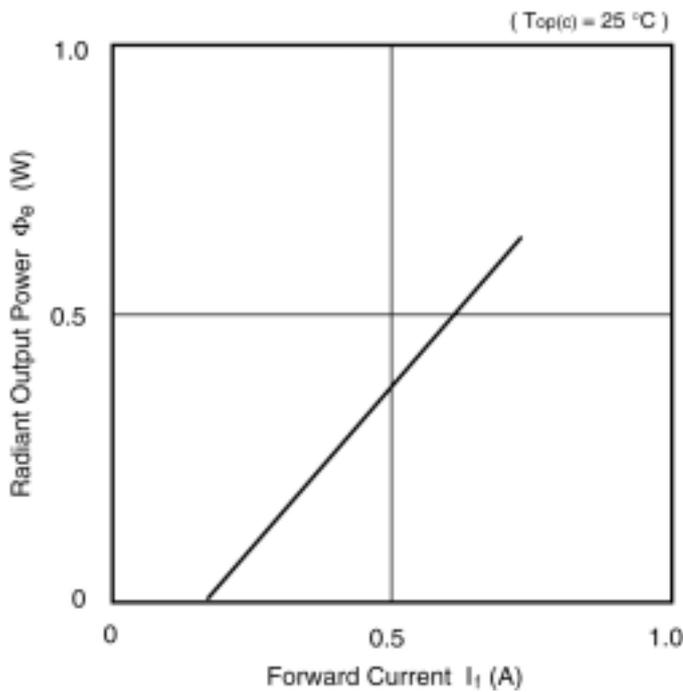


Figure 2: Emission Spectrum (Typ.)

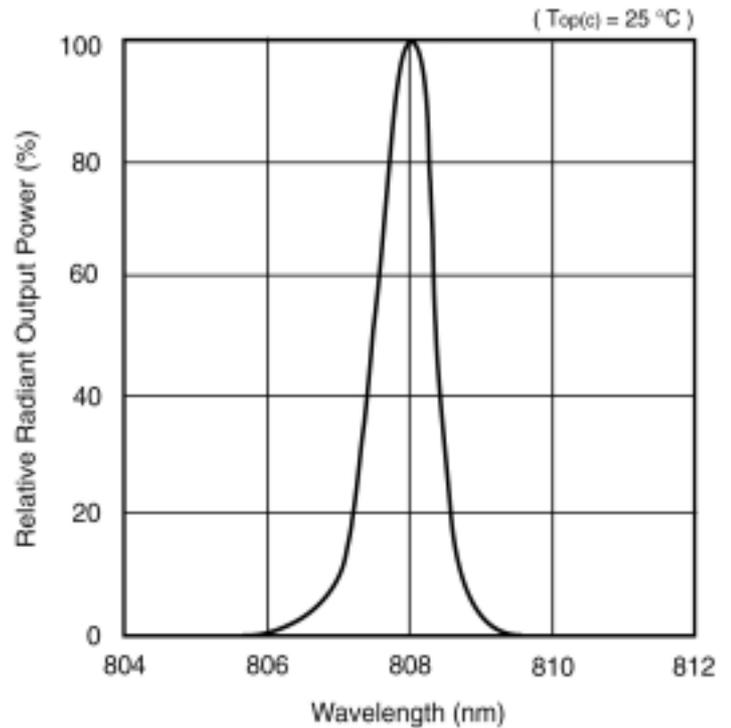
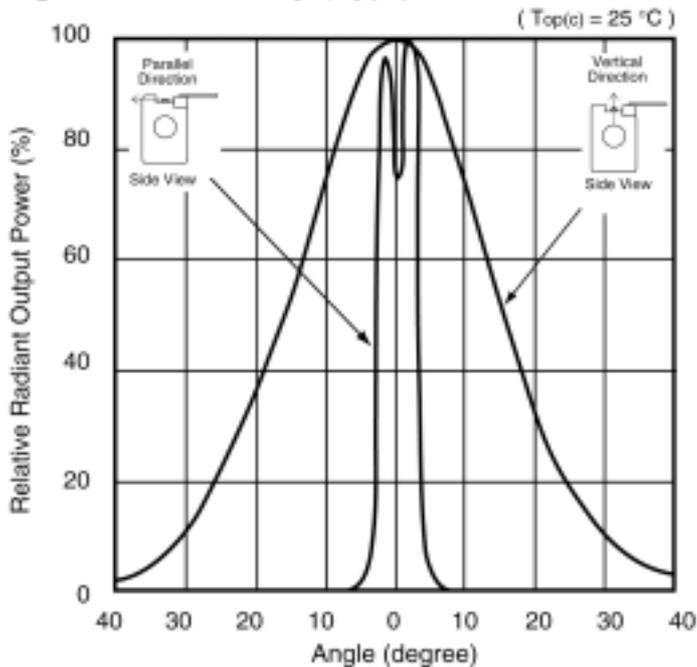


Figure 3: Directivity (Typ.)



■ INSTRUCTIONS FOR SAFETY USE

1. Heat dissipation

Reliability of this LD is deeply correlated with junction temperature. Under higher operating temperature, the reliability deteriorates soon. Heat dissipating device (material: Aluminum, Copper) should be attached to the base of the LD, and cooling devices (air, water, peltier etc.) should be operated with the LD in order to dissipate the heat from the LD, so that the operating temperature is kept within the absolute maximum ratings.

2. Safety for operators and users

This LD emits invisible laser radiation. It's classified into Class 4 according to the laser product standards of the IEC 60825-1 (Safety of laser products Part 1: Equipment classification, requirements and user's guide) and/or ANSI Z136.1 (American National Standard for Safe Use of Lasers) etc. Direct or reflected laser beam from this LD may damage eyes or skin by being absorbed by cell. The operator must not stare the emitting area of LD, must avoid direct exposure to the laser beam.

3. Bare chip type

This LD is bare chip type, vital & fragile part is naked. Dusts, expiration, finger print, sputum, condensation bending, chip off of LD chip, re-forming of wire may leads to degradation of performance of the LD. Please unpack, keep, handle, operate, and drive in air-conditioned clean rooms that the LD is keep away from dust & condensation.

HAMAMATSU

<http://www.hamamatsu.com>

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